

REVISIONS

LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
A	Make change to zero-code offset error test as specified in table I. Changes in accordance with N.O.R 5962-R125-96.	96-05-22	M. A. Frye
B	Make change to footnote 1 and add footnote 4 as specified in table I. Redrawn. – ro	98-02-24	R. Monnin
C	Updated drawing to reflect current requirements. – rrp	04-05-03	R. Monnin
D	Redrawn. Update paragraphs to MIL-PRF-38535 requirements.-.drw	16-05-05	Charles F. Saffle



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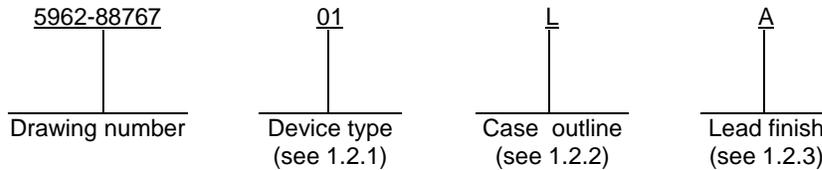
REV STATUS OF SHEETS	REV	D	D	D	D	D	D	D	D	D	D								
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PMIC N/A	PREPARED BY Dan Wonnell	<p align="center">DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990 http://www.landandmaritime.dla.mil</p>																	
<p align="center">STANDARD MICROCIRCUIT DRAWING</p> <p>THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE</p> <p align="center">AMSC N/A</p>	CHECKED BY Sandra Rooney																		
	APPROVED BY Michael A. Frye																		
	DRAWING APPROVAL DATE 93-12-20	MICROCIRCUIT, LINEAR, MULTIPLYING, 12-BIT, DIGITAL-TO-ANALOG CONVERTER, MONOLITHIC SILICON																	
	REVISION LEVEL D	<table border="1"> <tr> <td>SIZE A</td> <td>CAGE CODE 67268</td> <td>5962-88767</td> </tr> </table>	SIZE A	CAGE CODE 67268	5962-88767														
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1. SCOPE

1.1 Scope. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A.

1.2 Part or Identifying Number (PIN). The complete PIN is as shown in the following example:



1.2.1 Device types. The device types identify the circuit function as follows:

<u>Device type</u>	<u>Generic number</u>	<u>Circuit function</u>	<u>Relative Accuracy (INL)</u>
01	MAX502A	12-bit multiplying D/A converter	±0.5 LSB
02	MAX502B	12-bit multiplying D/A converter	±0.75 LSB

1.2.2 Case outline. The case outline is as designated in MIL-STD-1835 as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
L	GDIP3-T24 or CDIP4-T24	24	Dual-in-line

1.2.3 Lead finish. The lead finish is as specified in MIL-PRF-38535, appendix A.

1.3 Absolute maximum ratings.

V_{DD} to DGND.....	-0.3 V dc, +17 V dc
V_{SS} to DGND.....	+0.3 V dc, -17 V dc
V_{REF} to AGND.....	±25 V dc
RFB to AGND.....	±25 V dc
RA to AGND.....	±25 V dc
RB to AGND.....	±25 V dc
RC to AGND.....	±25 V dc
V_{OUT} to AGND.....	V_{DD} +0.3 V dc, V_{SS} -0.3 V dc <u>1/</u>
V_{DD} to AGND.....	-0.3 V dc, +17 V dc
AGND to DGND.....	-0.3 V dc, V_{DD}
Digital input voltage to DGND.....	-0.3 V dc, V_{DD}
Power dissipation (P_D), $T_A = +75^\circ\text{C}$	650 mW <u>2/</u>
Lead temperature (soldering, 10 seconds).....	+300°C
Storage temperature range.....	-65°C to +150°C
Thermal resistance, junction-to-case (θ_{JC}).....	See MIL-STD-1835

1.4 Recommended operating conditions.

Positive supply voltage (V_{DD}).....	+11.4 V dc to +15.75 V dc
Negative supply voltage (V_{SS}).....	-11.4 V dc to -15.75 V dc
Ambient operating temperature range (T_A).....	-55°C to +125°C

1/ V_{OUT} may be shorted to AGND, V_{DD} , or V_{SS} if the power dissipation of the package is not exceeded.

2/ Derate above $T_A = +75^\circ\text{C}$, 10 mW/°C.

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2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.
MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.
MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at <http://quicksearch.dla.mil> or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094).

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.

3.2.1 Case outline. The case outline shall be in accordance with 1.2.2 herein.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.3 Truth table. The truth table shall be as specified on figure 2.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full ambient operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

3.5 Marking. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device.

3.5.1 Certification/compliance mark. A compliance indicator "C" shall be marked on all non-JAN devices built in compliance to MIL-PRF-38535, appendix A. The compliance indicator "C" shall be replaced with a "Q" or "QML" certification mark in accordance with MIL-PRF-38535 to identify when the QML flow option is used.

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TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions <u>1/</u> , <u>2/</u> , <u>3/</u> -55°C ≤ T _A ≤ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Resolution	N		1, 2, 3	All	12		Bits
Relative accuracy	INL		1	01		±0.5	LSB
				02		±0.75	
			2, 3	01		±0.75	
				02		±1.0	
Differential Nonlinearity	DNL		1, 2, 3	All		±1.0	LSB
Zero-code offset error	V _{OE}		1	All		±2	mV
			2, 3			±3	
Gain error	A _E	RFB, V _{OUT} connected	1, 2, 3	All		±3.0	LSB
		RC or RB connected to V _{OUT} , V _{REF} = 5 V				±4.5	
		RA, V _{OUT} connected, V _{REF} = 2.5 V				±6.0	
Reference input resistance	R _{IN}		1, 2, 3	All	8	16	kΩ
Application resistor ratio matching	R _{MATCH}	RA to RB to RC match	1, 2, 3	All		0.5	%
Input current	I _{IN}	V _{IN} = 0 V and V _{DD}	1	All		1	μA
			2, 3			±10	
Input voltage low	V _{IL}		1, 2, 3	All		0.8	V
Input voltage high	V _{IH}		1, 2, 3	All	2.4		V
Supply current	I _{DD}	V _{OUT} unloaded	1, 2, 3	All		10	mA
	I _{SS}	V _{OUT} unloaded				4	

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - continued.

Test	Symbol	Conditions <u>1/</u> , <u>2/</u> , <u>3/</u> -55°C ≤ T _A ≤ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Power supply rejection	PSR	V _{REF} = -10 V, -8.9 V, V _{DD} = +15 V ±5 %, V _{DD} = +12 V ±5 %	1, 2, 3	All		±0.02	%/%
		V _{REF} = +10 V, +8.9 V, V _{SS} = -15 V ±5 %, V _{SS} = -12 V ±5 %				±0.02	
Output-voltage setting time	t _S	To ±0.01% of full scale <u>4/</u>	9, 10, 11	All		5	μs
Open-loop gain	A _{VO}	V _{OUT} = ±10 V, R _L = 2 kΩ <u>4/</u> RFB not connected	4, 5, 6	All	90		dB
Chip select to write-setup time	t _{CS}	See figure 3	9, 10, 11	All	0		ns
Write pulse width	t _{WR}	See figure 3	9	All	40		ns
			10, 11		60		
Data-setup time	t _{DS}	See figure 3	9, 10, 11	All	60		ns
Data-hold time	t _{DH}	See figure 3	9, 10, 11	All	10		ns
Functional test	FT	See 4.3.1b	7, 8	All			

1/ V_{REF} = +10 V dc, AGND = DGND = 0 V dc, R_L = 2 kΩ, and C_L = 100 pF. Dual supply: V_{DD} = +11.4 V to +15.75 V, V_{SS} = -11.4 to -15.75 V

2/ V_{OUT} must be less than V_{DD} - 2.5 V and greater than V_{SS} + 2.5 V to ensure correct operation.

3/ Unused feedback resistors should be shorted to analog ground.

4/ Parameter is guaranteed to the limits specified but is not tested.

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Device type	All
Case outline	L
Terminal number	Terminal symbol
1	V_{OUT}
2	D11
3	D10
4	D9
5	D8
6	D7
7	D6
8	D5
9	D4
10	D3
11	D2
12	DGND
13	D1
14	D0
15	\overline{WR}
16	\overline{CS}
17	V_{REF}
18	AGND
19	V_{SS}
20	V_{DD}
21	RA
22	RB
23	RC
24	RFB

FIGURE 1. Terminal connections.

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\overline{WR}	\overline{CS}	Operation
H	X	No operation
X	H	No operation
L	L	Input register is transparent
L	R	Input register is latched
R	L	Input register is latched

H = high state, L = low state, R = rising edge, X = don't care

FIGURE 2. Truth table.

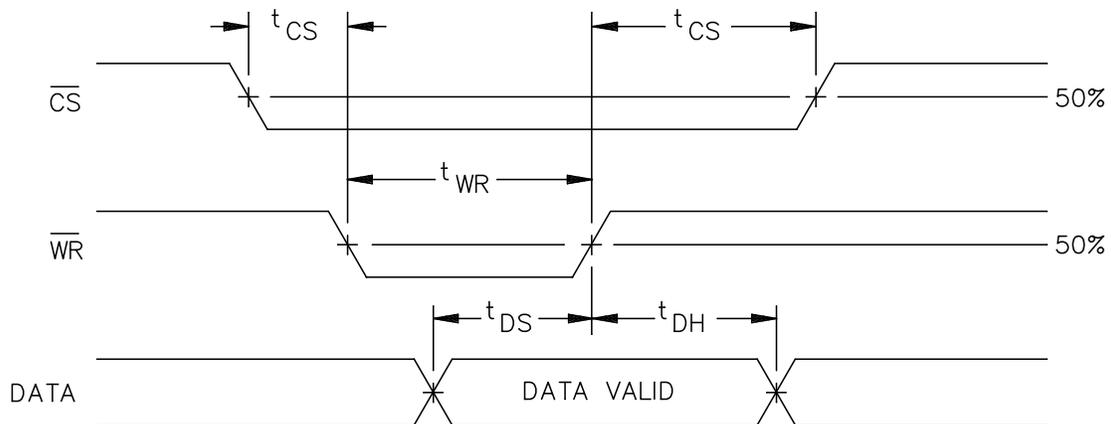


FIGURE 3. Timing diagram.

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3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DLA Land and Maritime -VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.

3.7 Certificate of conformance. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change. Notification of change to DLA Land and Maritime -VA shall be required for any change that affects this drawing.

3.9 Verification and review. DLA Land and Maritime, DLA Land and Maritime's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

4. VERIFICATION

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

- a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.
 - (2) $T_A = +125^{\circ}\text{C}$, minimum.
- b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)
Interim electrical parameters (method 5004)	1
Final electrical test parameters (method 5004)	1*, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11
Group A test requirements (method 5005)	1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11
Groups C and D end-point electrical parameters (method 5005)	1

* PDA applies to subgroup 1.

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4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 7 and 8 shall include verification of the truth table.

4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
 - (2) $T_A = +125^{\circ}\text{C}$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.

6.4 Record of users. Military and industrial users shall inform DLA Land and Maritime when a system application requires configuration control and the applicable SMD to that system. DLA Land and Maritime will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DLA Land and Maritime-VA, telephone (614) 692-8108.

6.5 Comments. Comments on this drawing should be directed to DLA Land and Maritime-VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0540.

6.6 Approved sources of supply. Approved sources of supply are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DLA Land and Maritime-VA.

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STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 16-05-05

Approved sources of supply for SMD 5962-88767 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DLA Land and Maritime-VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DLA Land and Maritime maintains an online database of all current sources of supply at <http://www.landandmaritime.dla.mil/Programs/Smcr/>.

Standard microcircuit drawing PIN <u>1/</u>	Vendor CAGE number	Vendor similar PIN <u>2/</u>
5962-8876701LA	1ES66	MAX502AMRG/883B
5962-8876702LA	1ES66	MAX502BMRG/883B

1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.

2/ **Caution.** Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE
number

1ES66

Vendor name
and address

Maxim Integrated
160 Rio Robles
San Jose, CA 95134

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